


Product Summary

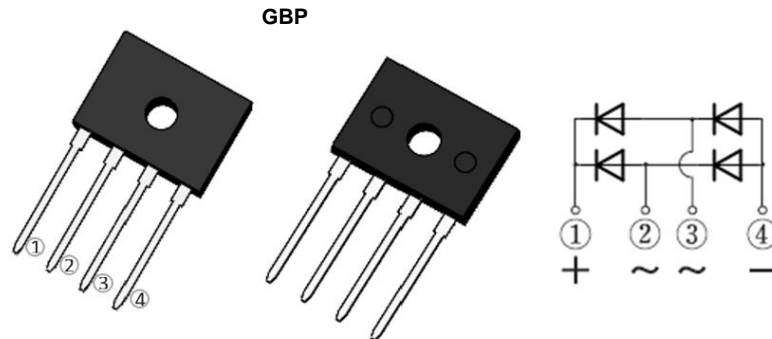
$V_{RRM}(V)$	$I_F(A)$	$V_F \text{ Max } (V)$ @ $I_F = 2.0A$	$I_R \text{ Max } (\mu A)$
600, 800, 1000	4	1.0	5

Mechanical Data

- Package: GBP
- Package Material: Plastic Material, UL Flammability Classification 94V-0 (No Br. Sb, Cl).
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 
- Polarity Indicator: Symbol Molded on Body
- Weight: 1.33 grams (Approximate)

Features

- Glass Passivated Die Construction
- Rating to 1000V PRV
- Ideal for Printed Circuit Board
- Reliable Construction Utilizing Molded Plastic
- UL Recognized File # E95060
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

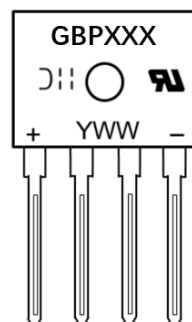



Ordering Information (Note 4)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
GBP406	GBP	35	Tube
GBP408	GBP	35	Tube
GBP410	GBP	35	Tube

- Notes:
- EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 - See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



GBPXXX = Product Type Marking Code
 = Manufacturer's Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 5 = 2025)
 WW = Week Code (01 to 53)

Maximum Ratings (@ $T_A = +25^{\circ}\text{C}$, unless otherwise specified.)

Characteristic	Symbol	GBP406	GBP408	GBP410	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	600	800	1000	V
Maximum DC Blocking Voltage	V_{DC}	600	800	1000	V
Maximum Average Rectified Output Current @ $T_C = +90^{\circ}\text{C}$	With Heatsink Without Heatsink $I_{F(AV)}$	4.0 2.1			A
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	$T_J = +25^{\circ}\text{C}$ $T_J = +125^{\circ}\text{C}$ I_{FSM}	135 120			A
Peak Forward Surge Current 1.0ms Single Half Sine Wave Superimposed on Rated Load	$T_J = +25^{\circ}\text{C}$ $T_J = +125^{\circ}\text{C}$ I_{FSM}	330 300			A
I^2t Rating for Fusing ($t = 8.3\text{ms}$)	I^2t	75			A^2s
Operating Temperature Range	T_J	-55 to +150			$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150			$^{\circ}\text{C}$

Electrical Characteristics

Characteristic	Test Conditions	Symbol	Max	Unit
Forward Voltage	$I_F = 2.0\text{A}$ $T_J = +25^{\circ}\text{C}$	V_F	1.0	V
Leakage Current	V_R at Rated $T_J = +25^{\circ}\text{C}$ $T_J = +125^{\circ}\text{C}$	I_R	5 500	μA
Typical Junction Capacitance (Note 5)		C_J	40	pF

Thermal Characteristics

Characteristic	Symbol	Typ	Unit
Typical Thermal Resistance (Note 6)	$R_{\theta JC}$	7.5	$^{\circ}\text{C/W}$

Notes: 5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 6. Thermal resistance junction to case. Device mounted on 50mm x 50mm x 2mm Cu plate heatsink.

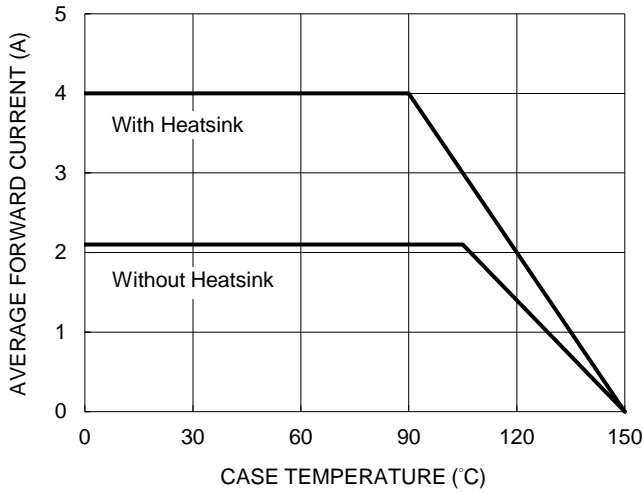


Figure 1. Forward Current Derating Curve

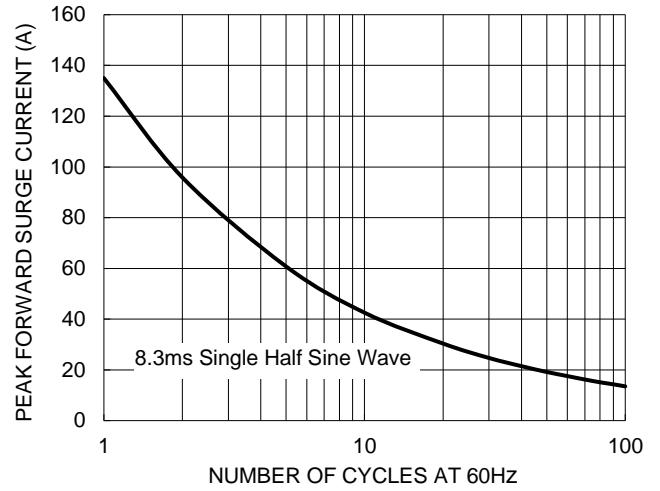


Figure 2. Maximum Non-Repetitive Surge Current

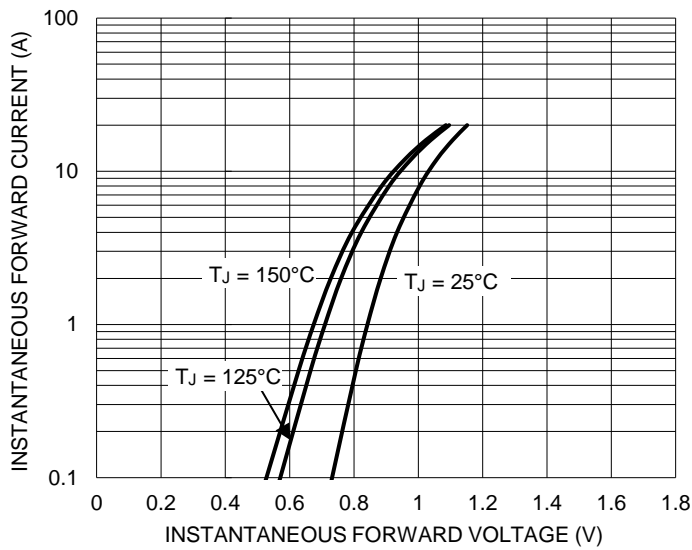


Figure 3. Typical Forward Characteristics

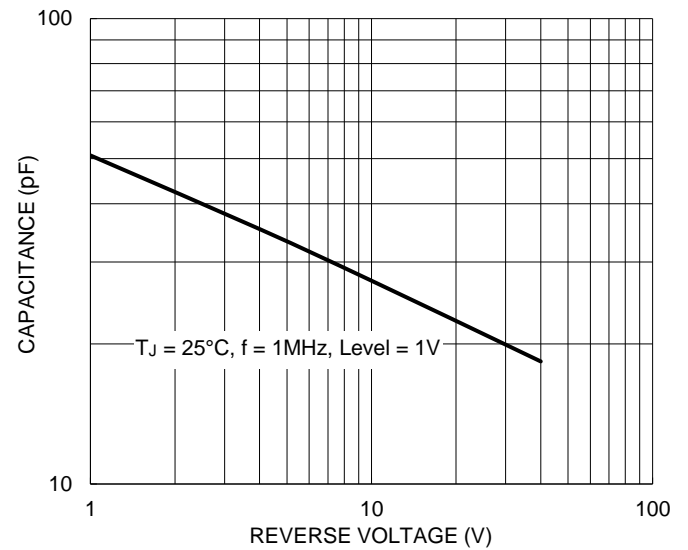


Figure 4. Typical Junction Capacitance

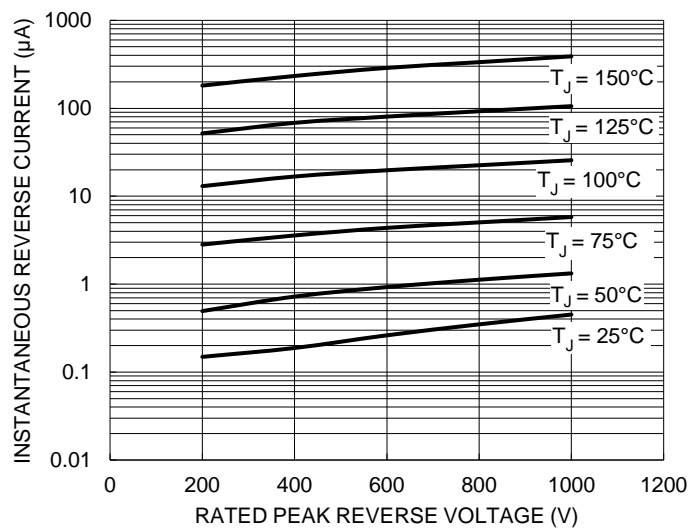


Figure 5. Typical Reverse Characteristics

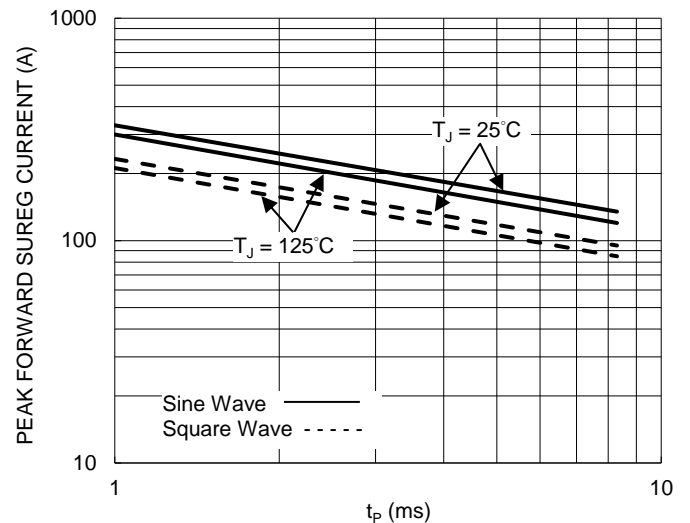
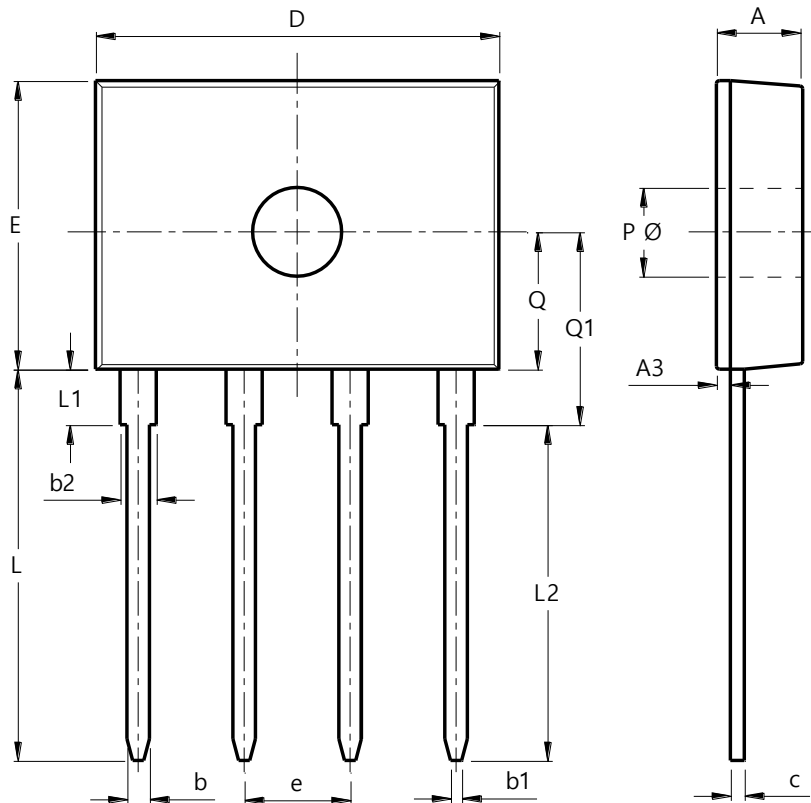


Figure 6. Non-Repetitive Surge Current

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

GBP



GBP			
Dim	Min	Max	TYP
A	2.90	3.30	3.10
A3	0.30	0.70	0.50
b	0.76	0.86	0.81
b1	0.35	0.45	0.40
b2	1.20	1.40	1.30
c	0.40	0.60	0.50
D	14.20	14.70	14.50
E	10.10	10.70	10.40
e	3.71	3.91	3.81
L	13.80	14.40	14.10
L1	1.80	2.20	2.00
L2	12.10 REF		
PØ	3.20 REF		
Q	4.65	5.25	4.95
Q1	6.65	7.25	6.95
All Dimensions in mm			

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